

Part Number: 702462004

Product Description: 2.54mm Pitch C-Grid Header, Low Profile, Dual Row, Vertical, Shrouded, 20 Circuits, 0.127µm Gold (Au)

Plating, Tin(Sn) PC Tail Plating

Status: Active

Series Number: 70246

Product Category: PCB Headers and

Receptacles

Documents & Resources

Drawings

Drawing 702462004_sd.pdf Packaging Design Drawing PK-87835-001-001.pdf

3D Models and Design Files

3D Model 702462004_stp.zip

Specifications

Application Specification 713080001-AS-000.pdf Product Specification PS-70246-100-001.pdf

Product Environment Compliance

Compliance

GADSL/IMDS	Compliant with Exemption 44; 34; 33
China RoHS	©
EU ELV	Not Relevant
Low-Halogen Status	Not Low-Halogen per IEC 61249-2- 21
REACH SVHC	Not Contained per D(2024)4144-DC (27 June 2024)
EU RoHS	Compliant per EU 2015/863

Multiple Part Product Compliance Statements

- Eu RoHS
- REACH SVHC
- Low-Halogen

Multiple Part Industry Compliance Documents

- IPC 1752A Class C

- IPC 1752A Class D
- Molex Product Compliance Declaration
- IEC-62474
- chemSHERPA (xml)

EU RoHS Certificate of Compliance

Part Details

General

Status	Active
Category	PCB Headers and Receptacles
Series	70246
Description	2.54mm Pitch C-Grid Header, Low Profile, Dual Row, Vertical, Shrouded, 20 Circuits, 0.127µm Gold (Au) Plating, Tin(Sn) PC Tail Plating
Application	Signal, Wire-to-Board
Component Type	PCB Header
Product Family	C-Grid and C-Grid III Connector Products
Product Name	C-Grid
UPC	822348757343

Agency

CSA	LR19980
UL	E29179

Electrical

Current - Maximum per Contact	2.5A
Voltage - Maximum	250V DC

Physical

Breakaway	No
Circuits (Loaded)	20
Circuits (maximum)	20
First Mate / Last Break	No
Flammability	94V-0

Glow-Wire Capable	No
Guide to Mating Part	No
Keying to Mating Part	None
Lock to Mating Part	None
Material - Plating Mating	Gold
Material - Plating Termination	Tin
Net Weight	2.547/g
Number of Rows	2
Orientation	Vertical
Packaging Type	Tray
PC Tail Length	3.43mm
PCB Locator	No
PCB Retention	None
PCB Thickness - Recommended	1.60mm
Pitch - Mating Interface	2.54mm
Pitch - Termination Interface	2.54mm
Plating min - Mating	0.127μm
Plating min - Termination	1.905µm
Polarized to Mating Part	Yes
Polarized to PCB	No
Shrouded	Closed Ends
Stackable	No
Temperature Range - Operating	-55° to +120°C
Termination Interface Style	Through Hole

Solder Process Data

Max-Duration	10
Lead-Free Process Capability	WAVE
Max-Cycle	1
Max-Temp	235

Mates With / Use With

Mates with Part(s)

Description Part Number

C-Grid Vertical, Dual Row, High Profile, Surface Mount PCB Connectors	71395
C-Grid Vertical, Dual Row, High Profile, Through Hole PCB Receptacles	<u>71850</u>
SL Dual Row Crimp Housings	70450

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